

## 54F/74F109 Dual JK Positive Edge-Triggered Flip-Flop

### General Description

The 'F109 consists of two high-speed, completely independent transition clocked JK flip-flops. The clocking operation is independent of rise and fall times of the clock waveform. The JK design allows operation as a D flip-flop (refer to 'F74 data sheet) by connecting the J and  $\bar{K}$  inputs.

Asynchronous Inputs:

LOW input to  $\bar{S}_D$  sets Q to HIGH level

LOW input to  $\bar{C}_D$  sets Q to LOW level

Clear and Set are independent of clock

Simultaneous LOW on  $\bar{C}_D$  and  $\bar{S}_D$  makes both Q and  $\bar{Q}$  HIGH

### Features

- Guaranteed 4000V minimum ESD protection.

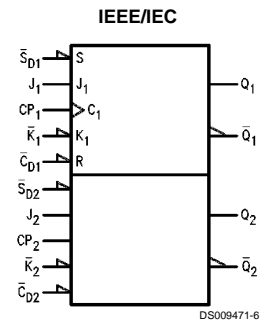
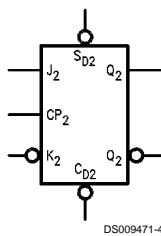
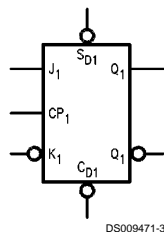
**Ordering Code:** See Section 0

Commercial	Military	Package Number	Package Description
74F109PC		N16E	16-Lead (0.300" Wide) Molded Dual-in-Line
	54F109DM (Note 2)	J16A	16-Lead Ceramic Dual-in-Line
74F109SC (Note 1)		M16A	16-Lead (0.150" Wide) Molded Small Outline, JEDEC
74F109SJ (Note 1)		M16D	16-Lead (0.300" Wide) Molded Small Outline, EIAJ
	54F109FM (Note 2)	W16A	16-Lead Cerpack
	54F109LM (Note 2)	E20A	16-Lead Ceramic Leadless Chip Carrier, Type C

**Note 1:** Devices also available in 13" reel. Use suffix = SCX and SJX.

**Note 2:** Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

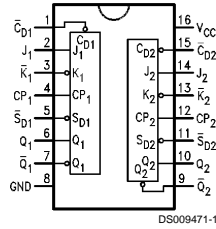
### Logic Symbols



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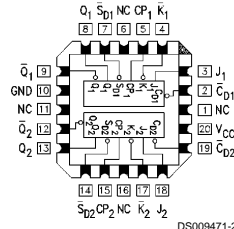
## Connection Diagrams

Pin Assignment  
for DIP, SOIC and Flatpak



DS009471-1

Pin Assignment  
for LCC



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## Unit Loading/Fan Out

See Section 0 for U.L. definitions

Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input $I_{IH}/I_{IL}$ Output $I_{OH}/I_{OL}$
$J_1, J_2, \bar{K}_1, \bar{K}_2$	Data Inputs	1.0/1.0	20 $\mu$ A/-0.6 mA
$CP_1, CP_2$	Clock Pulse Inputs (Active Rising Edge)	1.0/1.0	20 $\mu$ A/-0.6 mA
$\bar{C}_{D1}, \bar{C}_{D2}$	Direct Clear Inputs (Active LOW)	1.0/3.0	20 $\mu$ A/-1.8 mA
$\bar{S}_{D1}, \bar{S}_{D2}$	Direct Set Inputs (Active LOW)	1.0/3.0	20 $\mu$ A/-1.8 mA
$Q_1, Q_2, \bar{Q}_1, \bar{Q}_2$	Outputs	50/33.3	-1 mA/20 mA

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## Truth Table

Inputs					Outputs	
$\bar{S}_D$	$\bar{C}_D$	CP	J	$\bar{K}$	Q	$\bar{Q}$
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H	H
H	H	↗	l	l	L	H
H	H	↗	h	l	Toggle	
H	H	↗	l	h	$Q_0$	$\bar{Q}_0$
H	H	↗	h	h	H	L
H	H	L	X	X	$Q_0$	$\bar{Q}_0$

H (h) = HIGH Voltage Level

L (l) = LOW Voltage Level

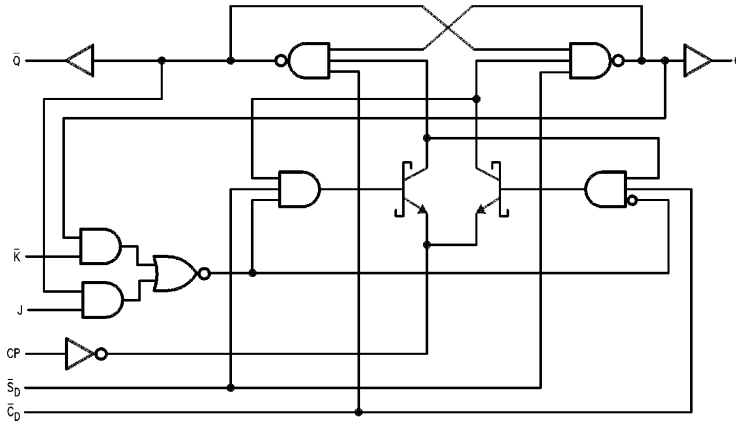
↗ = LOW-to-HIGH Transition

X = Immaterial

$Q_0$  ( $\bar{Q}_0$ ) = Before LOW-to-HIGH Transition of Clock

Lower case letters indicate the state of the referenced output one setup time prior to the LOW-to-HIGH clock transition.

**Logic Diagram** (One Half Shown)



DS009471-5

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

### Absolute Maximum Ratings (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 4)	-0.5V to +7.0V
Input Current (Note 4)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V <sub>CC</sub> = 0V)	
Standard Output	-0.5V to V <sub>CC</sub>
TRI-STATE® Output	-0.5V to +5.5V

Current Applied to Output in LOW State (Max) twice the rated I<sub>OL</sub> (mA)  
 ESD Last Passing Voltage (Min) 4000V

### Recommended Operating Conditions

Free Air Ambient Temperature	
Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

**Note 3:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 4:** Either voltage limit or current limit is sufficient to protect inputs.

### DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V <sub>CC</sub>	Conditions		
		Min	Typ	Max					
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal		
V <sub>IL</sub>	Input LOW Voltage				V		Recognized as a LOW Signal		
V <sub>CD</sub>	Input Clamp Diode Voltage				V	Min	I <sub>IN</sub> = -18 mA		
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub>	2.5		V	Min	I <sub>OH</sub> = -1 mA		
		74F 10% V <sub>CC</sub>	2.5				I <sub>OH</sub> = -1 mA		
		74F 5% V <sub>CC</sub>	2.7				I <sub>OH</sub> = -1 mA		
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub>	0.5		V	Min	I <sub>OL</sub> = 20 mA		
		74F 10% V <sub>CC</sub>	0.5				I <sub>OL</sub> = 20 mA		
I <sub>IH</sub>	Input HIGH Current	54F	20.0		µA	Max	V <sub>IN</sub> = 2.7V		
		74F	5.0						
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F	100		µA	Max	V <sub>IN</sub> = 7.0V		
		74F	7.0						
I <sub>CEx</sub>	Output HIGH Leakage Current	54F	250		µA	Max	V <sub>OUT</sub> = V <sub>CC</sub>		
		74F	50						
V <sub>ID</sub>	Input Leakage Test	74F	4.75		V	0.0	I <sub>ID</sub> = 1.9 µA All Other Pins Grounded		
I <sub>OD</sub>	Output Leakage Circuit Current	74F	3.75		µA	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded		
I <sub>IL</sub>	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V (J <sub>n</sub> , K <sub>n</sub> ) V <sub>IN</sub> = 0.5V (C <sub>Dn</sub> , S <sub>Dn</sub> )	
					-1.8				
I <sub>OS</sub>	Output Short-Circuit Current				-60	-150	mA	Max	V <sub>OUT</sub> = 0V
I <sub>CC</sub>	Power Supply Current				11.7	17.0			

### AC Electrical Characteristics

See Section 0 for Waveforms and Load Configurations

Symbol	Parameter	74F			54F		74F		Units	Fig. No.
		T <sub>A</sub> = +25°C V <sub>CC</sub> = +5.0V C <sub>L</sub> = 50 pF			T <sub>A</sub> , V <sub>CC</sub> = Mil C <sub>L</sub> = 50 pF		T <sub>A</sub> , V <sub>CC</sub> = Com C <sub>L</sub> = 50 pF			
		Min	Typ	Max	Min	Max	Min	Max		
f <sub>max</sub>	Maximum Clock Frequency	100	125		70		90	MHz	◆◆◆◆	

## AC Electrical Characteristics (Continued)

See Section 0 for Waveforms and Load Configurations

Symbol	Parameter	74F			54F		74F		Units	Fig. No.
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$ $C_L = 50\text{ pF}$			$T_A, V_{CC} = \text{Mil}$ $C_L = 50\text{ pF}$		$T_A, V_{CC} = \text{Com}$ $C_L = 50\text{ pF}$			
		Min	Typ	Max	Min	Max	Min	Max		
$t_{PLH}$	Propagation Delay	3.8	5.3	7.0	3.8	9.0	3.8	8.0	ns	◆◆◆
$t_{PHL}$	$CP_n$ to $Q_n$ or $\bar{Q}_n$	4.4	6.2	8.0	4.4	10.5	4.4	9.2		
$t_{PLH}$	Propagation Delay	3.2	5.2	7.0	3.2	9.0	3.2	8.0		
$t_{PHL}$	$\bar{C}_{Dn}$ or $\bar{S}_{Dn}$ to $Q_n$ or $\bar{Q}_n$	3.5	7.0	9.0	3.5	11.5	3.5	10.5	ns	◆◆◆

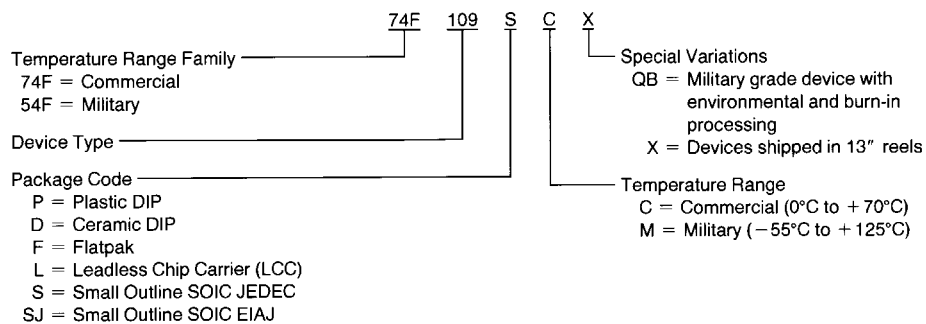
## AC Operating Requirements

See Section 0 for Waveforms

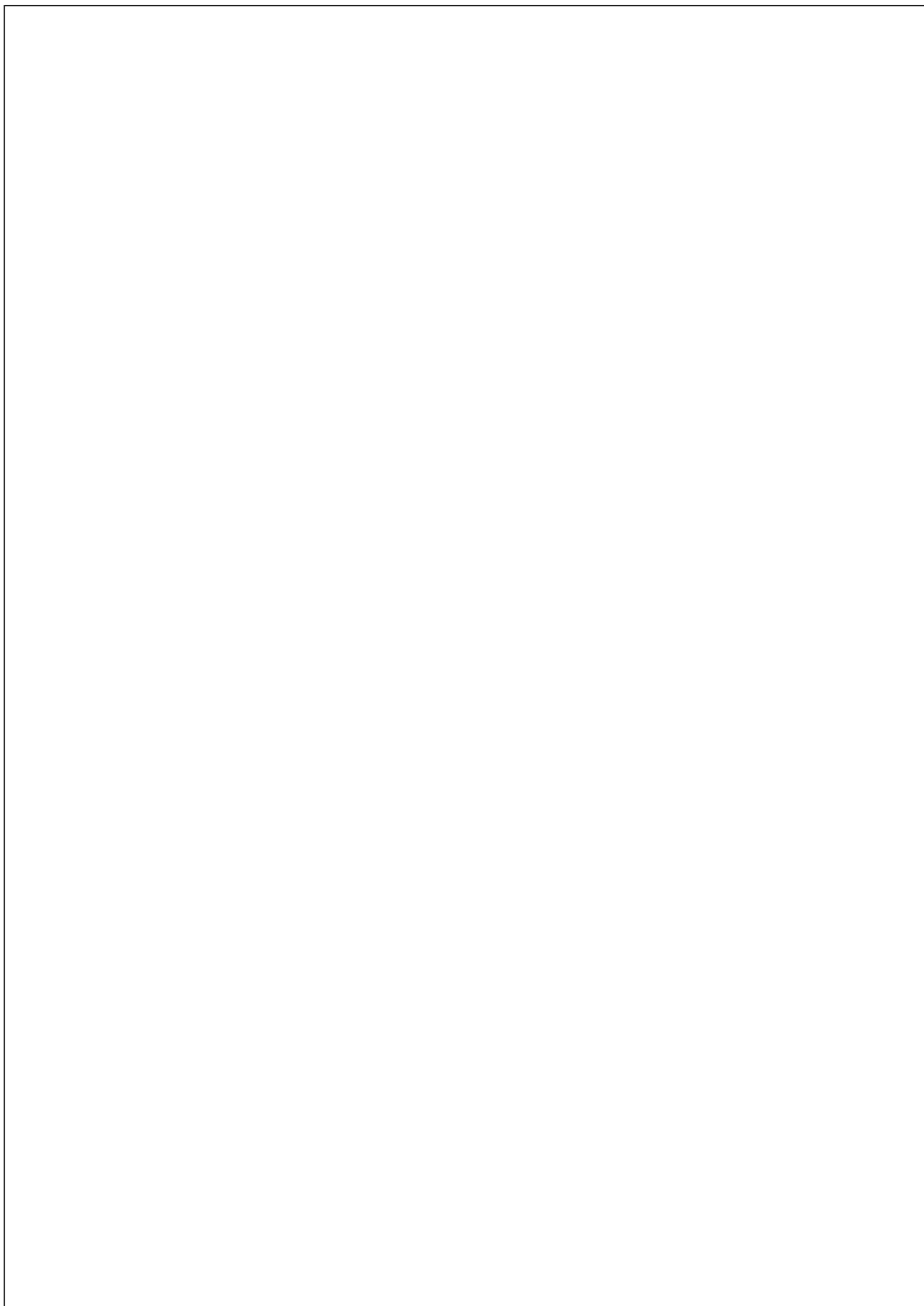
Symbol	Parameter	74F		54F		74F		Units	Fig. No.
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$		$T_A, V_{CC} = \text{Mil}$		$T_A, V_{CC} = \text{Com}$			
		Min	Max	Min	Max	Min	Max		
$t_s(H)$	Setup Time, HIGH or LOW	3.0		3.0		3.0			
$t_s(L)$	$J_n$ or $\bar{K}_n$ to $CP_n$	3.0		4.0		3.0		ns	◆◆◆
$t_h(H)$	Hold Time, HIGH or LOW	1.0		1.0		1.0			
$t_h(L)$	$J_n$ or $\bar{K}_n$ to $CP_n$	1.0		1.0		1.0			
$t_w(H)$	$CP_n$ Pulse Width	4.0		4.0		4.0		ns	◆◆◆
$t_w(L)$	HIGH or LOW	5.0		5.0		5.0			
$t_w(L)$	$\bar{C}_{Dn}$ or $\bar{S}_{Dn}$ Pulse Width, LOW	4.0		4.0		4.0		ns	◆◆◆
$t_{rec}$	Recovery Time $\bar{C}_{Dn}$ or $\bar{S}_{Dn}$ to CP	2.0		2.0		2.0		ns	◆◆◆

## Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

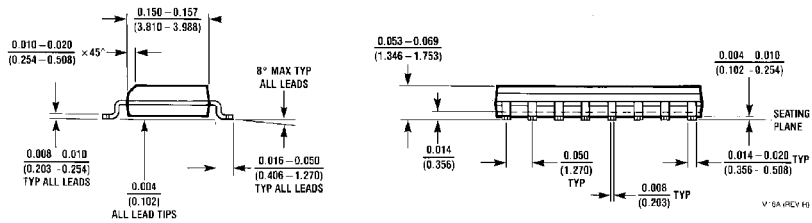
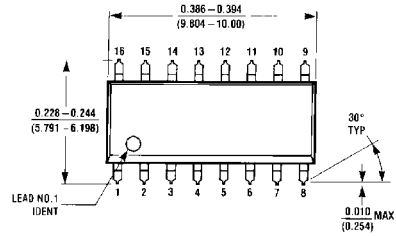


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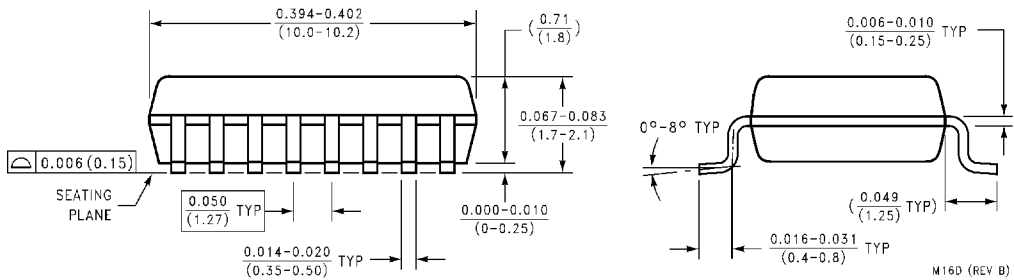
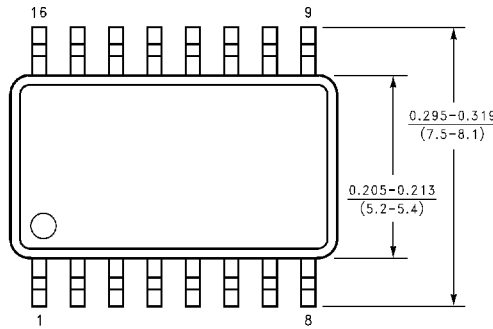




**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**16-Lead (0.150" Wide) Molded Small Outline Package, JEDEC (S)  
NS Package Number M16A**



**16-Lead (0.300" Wide) Molded Small Outline Package, EIAJ (SJ)  
NS Package Number M16D**






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